

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JOCHEN SCHMITT	05/06/2022
MICHAEL J. CUSACK	04/25/2022
ENDA JOSEPH NICHOLL	06/22/2022
BRIAN O'MARA	06/23/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ANALOG DEVICES INTERNATIONAL UNLIMITED COMPANY
<b>Street Address:</b>	BAY F1 RAHEEN INDUSTRIAL ESTATE
<b>City:</b>	LIMERICK
<b>State/Country:</b>	IRELAND
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17169180
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(949)760-9502
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	9497600404
<b>Email:</b>	efiling@knobbe.com
<b>Correspondent Name:</b>	KNOBBE, MARTENS, OLSON & BEAR LLP
<b>Address Line 1:</b>	2040 MAIN STREET, 14TH FLOOR
<b>Address Line 4:</b>	IRVINE, CALIFORNIA 92614
<b>ATTORNEY DOCKET NUMBER:</b>	ADIRE.315A
<b>NAME OF SUBMITTER:</b>	YUSUKE HIRAI
<b>SIGNATURE:</b>	/Yusuke Hirai/
<b>DATE SIGNED:</b>	06/23/2022
<b>Total Attachments: 5</b>	
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## ASSIGNMENT

WHEREAS, **Jochen Schmitt, Michael J. Cusack, Enda Joseph Nicholl, and Brian O'Mara** of residences listed below, having invented certain new and useful improvements as described in an application for United States Letters Patent entitled "MAGNETIC FIELD SENSOR PACKAGE," (hereinafter referred to as "Application") and having internal reference number of APD7271US01.

**WHEREAS**, I hereby authorize and request the attorneys or agents associated with United States Patent and Trademark Office Customer No. 110,833 to insert here in parentheses (Serial. No. 17/169,180 Filing Date: February 5, 2021) the filing date and serial number of the Application when known;

**WHEREAS**, Analog Devices International Unlimited Company (hereinafter referred to as "Assignee"), a company organized under the laws of Ireland and residing at Bay F1 Raheen Industrial Estate, Limerick, Ireland, desires to acquire my entire right, title and interest in and to any and all inventions and improvements that are disclosed in the Application (hereinafter referred to as "Invention"), including any Letters Patent that may issue thereon;

**NOW, THEREFORE**, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign and transfer, and hereby agree to assign and transfer, to Assignee, all right, title and interest in and to the Invention and in and to the Application and all patents which may be granted therefrom, and all related applications, (e.g., provisional applications, divisional applications, reissues, reexaminations, continuation applications, continuation-in-part applications, extensions thereof, design applications, applications in foreign countries, international applications, national phase applications, and the like). I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents, for the Invention, or patents resulting therefrom, insofar as my interest is concerned, to Assignee.

I also hereby assign and transfer, and hereby agree to assign and transfer to Assignee, all right, title and interest to the Invention, the Application or any related application throughout the world, including all rights of priority resulting from the filing of the Application or any related application, including but not limited to: the right to file applications and obtain patents, utility models, industrial models and designs for the Invention in Assignee's own name throughout the world, the right to claim priority from the Application or any related application when filing applications and obtaining patents, utility models, industrial models and designs for the Invention throughout the world, and all rights to publish cautionary notices reserving ownership of the Invention and all rights to register the Invention in appropriate registries. I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such right, title and interest in and to Assignee.

I will communicate to Assignee any facts known to me respecting any improvements to the Invention; and I will sign all lawful papers, execute all rightful assignments, execute all provisional, divisional, continuation, continuation-in-part, reissue and substitute applications, make lawful oaths and declarations, and generally do everything possible to vest title in and to Assignee and to aid Assignee to obtain and enforce proper protection for the Invention in all countries and jurisdictions throughout the world. I irrevocably appoint Analog Devices, Inc. as my attorney-in-fact to execute on my behalf any documents deemed necessary by Analog Devices, Inc. to obtain and enforce proper protection for the Invention in all countries and jurisdictions throughout the world. I agree to testify and cooperate with Assignee in any judicial proceeding, administrative proceeding, post-grant proceeding, or other proceeding concerning the Invention (including litigation with a third party over any patent issued on the Invention), and Assignee agrees to cover my reasonable costs and expenses (if any).

This Assignment shall be binding on the parties' successors, assigns and legal representatives.

Title of Invention: MAGNETIC FIELD SENSOR PACKAGE

Full Name of Inventor: Jochen Schmitt

Inventor's Signature: J. Schmitt

Date: May 6th 2022

Inventor's Home Address: Am Frauenberg 18  
Biedenkopf, 35216, Germany

Witness's Printed Name: Constanze Schmitt

Witness's Signature: C. Schmitt

Witness's Home Address: Am Frauenberg 18  
35216 Biedenkopf  
Germany

Title of Invention: MAGNETIC FIELD SENSOR PACKAGE

Full Name of Inventor: Michael J. Cusack

Inventor's Signature:

Michael Cusack

Date:

20/4/22

Inventor's Home Address:

Ballysallagh West  
Newmarket-on-Fergus, Ireland

Witness's Printed Name:

Rigán McBeahan

Witness's Signature:

Rigán McBeahan

Witness's Home Address:

16 Henkete Lane,  
Wexford, Ireland.

Title of Invention: MAGNETIC FIELD SENSOR PACKAGE

Full Name of Inventor: Enda Joseph Nicholl

Inventor's Signature:

Enda Nicholl

Date:

June 22<sup>nd</sup> 2022

Inventor's Home Address:

Rawleystown, Grange

Kilmallock, Ireland

Witness's Printed Name:

RONA SPILLANE

Witness's Signature:

Rona Spillane

Witness's Home Address:

192 THE GRANGE

RAHEEN, LIMERICK

Title of Invention: MAGNETIC FIELD SENSOR PACKAGE

Full Name of Inventor: Brian O'Mara

Inventor's Signature: Brian O'Mara

Date: 23rd June 2022

Inventor's Home Address: Grange

Lisnagry, Ireland

Witness's Printed Name: DOMINIC SLOAN

Witness's Signature: D. Sloan

Witness's Home Address: 33 MONALEEN PK.  
CASTLEBOY  
CO. LIMERICK.

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